Dual Matched 40 V, 6.0 A, Low V_{CE(sat)} PNP Transistor

These transistors are part of the ON Semiconductor e^2 PowerEdge family of Low $V_{CE(sat)}$ transistors. They are assembled to create a pair of devices highly matched in all parameters, including ultra low saturation voltage $V_{CE(sat)}$, high current gain and Base/Emitter turn on voltage.

Typical applications are current mirrors, differential amplifiers, DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- Current Gain Matching to 10%
- Base Emitter Voltage Matched to 2 mV
- AEC-Q101 Qualified and PPAP Capable
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These are Pb-Free Devices*

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit	
Collector-Emitter Voltage	V _{CEO}	-40	Vdc	
Collector-Base Voltage	V _{CBO}	-40	Vdc	
Emitter-Base Voltage	V _{EBO}	-7.0	Vdc	
Collector Current - Continuous	Ic	-3.0	Α	
Collector Current - Peak	I _{CM}	-6.0	Α	
Electrostatic Discharge	ESD	HBM Class 3B MM Class C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



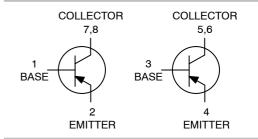
ON Semiconductor®

http://onsemi.com

$\begin{array}{c} \text{40 VOLTS} \\ \text{6.0 AMPS} \\ \text{PNP LOW V}_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \text{EQUIVALENT R}_{\text{DS(on)}} \text{ 80 m} \Omega \end{array}$



SOIC-8 CASE 751 STYLE 29



MARKING DIAGRAM



P40300 = Specific Device Code A = Assembly Location

Y = Year WW = Work Week • Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NSS40300MDR2G	SOIC-8 (Pb-Free)	2,500 / Tape & Reel
NSV40300MDR2G	SOIC-8 (Pb-Free)	2,500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
SINGLE HEATED	<u>,</u>		
Total Device Dissipation (Note 1) T _A = 25°C Derate above 25°C	P _D	576 4.6	mW mW/°C
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{ heta JA}$	217	°C/W
Total Device Dissipation (Note 2) $T_A = 25^{\circ}C$ Derate above 25°C	P _D	676 5.4	mW mW/°C
Thermal Resistance Junction-to-Ambient (Note 2)	$R_{ heta JA}$	185	°C/W
DUAL HEATED (Note 3)	•		
Total Device Dissipation (Note 1) T _A = 25°C Derate above 25°C	P _D	653 5.2	mW mW/°C
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{ hetaJA}$	191	°C/W
Total Device Dissipation (Note 2) T _A = 25°C Derate above 25°C	P _D	783 6.3	mW mW/°C
Thermal Resistance Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	160	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

FR-4 @ 10 mm², 1 oz. copper traces, still air.
 FR-4 @ 100 mm², 1 oz. copper traces, still air.
 Dual heated values assume total power is the sum of two equally powered devices.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	- 1		1	•	
Collector – Emitter Breakdown Voltage ($I_C = -10$ mAdc, $I_B = 0$)	V _(BR) CEO	-40	-	-	Vdc
Collector – Base Breakdown Voltage (I _C = -0.1 mAdc, I _E = 0)	V _(BR) CBO	-40	-	-	Vdc
Emitter – Base Breakdown Voltage (I _E = -0.1 mAdc, I _C = 0)	V _{(BR)EBO}	-7.0	-	-	Vdc
Collector Cutoff Current (V _{CB} = -40 Vdc, I _E = 0)	I _{CBO}	-	-	-0.1	μAdc
Emitter Cutoff Current (V _{EB} = -6.0 Vdc)	I _{EBO}	-	-	-0.1	μAdc
ON CHARACTERISTICS	·				
DC Current Gain (Note 4) $ \begin{array}{l} \text{(I}_C = -10 \text{ mA, V}_{CE} = -2.0 \text{ V}) \\ \text{(I}_C = -500 \text{ mA, V}_{CE} = -2.0 \text{ V}) \\ \text{(I}_C = -500 \text{ mA, V}_{CE} = -2.0 \text{ V}) \\ \text{(I}_C = -1.0 \text{ A, V}_{CE} = -2.0 \text{ V}) \\ \text{(I}_C = -2.0 \text{ A, V}_{CE} = -2.0 \text{ V}) \\ \text{(I}_C = -2.0 \text{ A, V}_{CE} = -2.0 \text{ V}) \text{ (Note 5)} \end{array} $	h _{FE}	250 220 180 150 0.9	380 340 300 230 0.99	- - - -	
Collector – Emitter Saturation Voltage (Note 4)	V _{CE(sat)}	- - - -	-0.013 -0.075 -0.130 -0.135	-0.017 -0.095 -0.170 -0.170	V
Base – Emitter Saturation Voltage (Note 4) $(I_C = -1.0 \text{ A}, I_B = -0.01 \text{ A})$	V _{BE(sat)}	-	-0.780	-0.900	V
Base – Emitter Turn-on Voltage (Note 4) $(I_C = -0.1 \text{ A, V}_{CE} = -2.0 \text{ V})$ $(I_C = -0.1 \text{ A, V}_{CE} = -2.0 \text{ V})$ (Note 6)	V _{BE(on)} V _{BE(1) -} V _{BE(2)}	- -	-0.660 0.3	-0.750 2.0	V mV
Cutoff Frequency ($I_C = -100 \text{ mA}$, $V_{CE} = -5.0 \text{ V}$, $f = 100 \text{ MHz}$)	f _T	100	-	-	MHz
Input Capacitance (V _{EB} = -0.5 V, f = 1.0 MHz)	Cibo	_	250	300	pF
Output Capacitance (V _{CB} = -3.0 V, f = 1.0 MHz)	Cobo	-	50	65	pF
SWITCHING CHARACTERISTICS	•	•	•	•	
Delay ($V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$)	t _d	_	_	60	ns
Rise ($V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$)	t _r	-	_	120	ns
Storage ($V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$)	t _s	_	_	400	ns
Fall ($V_{CC} = -30 \text{ V}$, $I_C = -750 \text{ mA}$, $I_{B1} = -15 \text{ mA}$)	t _f	-	_	130	ns

Pulsed Condition: Pulse Width = 300 μsec, Duty Cycle ≤ 2%.
 h_{FE(1)}/h_{FE(2)} is the ratio of one transistor compared to the other transistor within the same package. The smaller h_{FE} is used as numerator.
 V_{BE(1)} - V_{BE(2)} is the absolute difference of one transistor compared to the other transistor within the same package.

TYPICAL CHARACTERISTICS

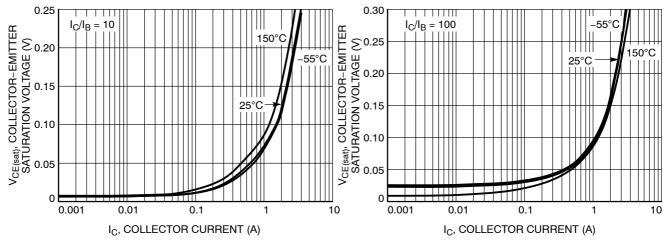


Figure 1. Collector Emitter Saturation Voltage vs. Collector Current

Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

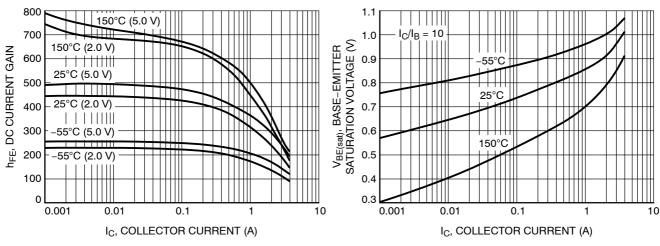


Figure 3. DC Current Gain vs. Collector Current

Figure 4. Base Emitter Saturation Voltage vs.
Collector Current

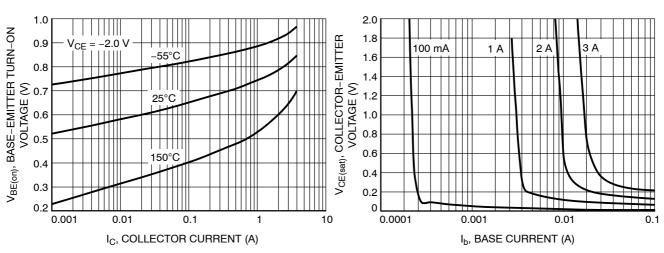


Figure 5. Base Emitter Turn-On Voltage vs.
Collector Current

Figure 6. Saturation Region

TYPICAL CHARACTERISTICS

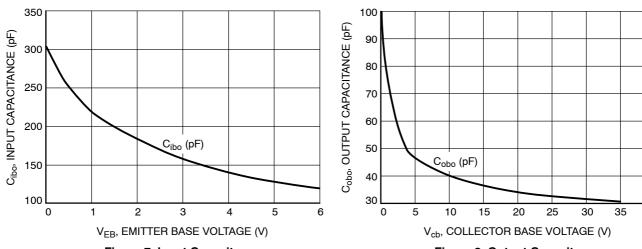


Figure 7. Input Capacitance

Figure 8. Output Capacitance

40

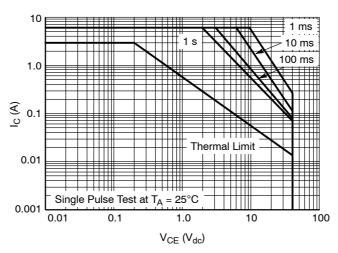
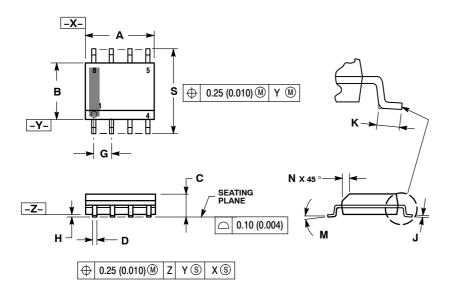
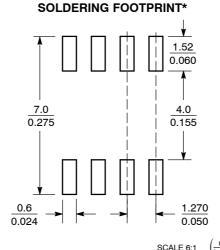


Figure 9. Safe Operating Area

PACKAGE DIMENSIONS

SOIC-8 NB CASE 751-07 **ISSUE AK**





*For additional information on our Pb-Free strategy and soldering Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27	1.27 BSC		0 BSC
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

STYLE 29

- BASE, DIE #1 PIN 1.
 - 2. EMITTER, #1
 - BASE #2 3
 - EMITTER, #2
 - COLLECTOR, #2 6. COLLECTOR, #2
 - COLLECTOR, #1
 - COLLECTOR, #1

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